To: Commissioner for
Please record the attac

To: Commissioner for Patents	03099934	Date: October 5, 2005			
Please record the attached original documents		Attorney Docket No. 5649-1707			
1. Name of conveying party(ies):		2. Name and address of receiving party(ies):			
[1.] Pan-Suk Kwak Additional name(s) of conveying party(ies) attached? Yes _X_ No		Samsung Electronics Co., Ltd. 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do			
		REPUBLIC OF KOREA			
3. Nature of conveyance:		£ 1.5			
X Assignment Merger Security Agreement Change of Name Other Execution Date: [1.] September 26, 2005		Additional name(s) & address(es) attached? Yes X_ No			
4. Application Serial No.					
If this document is being filed together wit is: September 26, 2005		the execution date of the application			
Additional numbers attached? Yes	X_No				
Name and address of party to whom correspondence concerning document should be mailed: Needham James Boddie, II		6. Total number of applications and patents involved: 1 7. Total fee (37 CFR 3.41) \$40.00 X Enclosed			
Myers Bigel Sibley & Sajovec P. O. Box 37428		Authorized to be charged to deposit account			
Raleigh NC 27627		8. Deposit account number: 50-0220			
DO NOT USE THIS SPAC	CE				
9. Statement and signature To the best of my knowledge and belief, the of the original document.	e foregoing informa	tion is true and correct and any attached copy is a true copy			
Northern Lance Boddin W. Box No. 40.6	\sim \sim	J Bodel- II October 5-2005			
Needham James Boddie, II, Reg. No. 40,5 Name of Person Signing	Signature	Date &			
Total number of pages including cover sheet,	attachments and do				
Express Mail Label No. EV 675789711 US Date of Deposit: October 5, 2005 I hereby certify that this correspondence is being ounder, 37 CFR § 110 on the date indicated above	leposited with the Un	EXPRESS MAILING ited States Postal Service "Express Mail Post Office to Addressee" service ommissioner for Patents, P.O. Box 1450, Sexandria, VA 22313-1450.			
Erin A. Campion		SDIRET#1			
10/07/2005 SDIRETA1 00000093 11243741		10/07/2005 04 FC:8021			

PATENT

REEL: 017067 FRAME: 0608

ASSIGNMENT

THIS ASSIGNMENT, made by me, **Pan-Suk Kwak**, citizen of the Republic of Korea, residing at 1104-302, Jugong Apt., Jinahngol maeul, Jinahn-ri, Taeahn-eup, Hwaseong-si, Gyeonggi-do, Republic of Korea;

WITNESSETH: That,

WHEREAS, I am the sole inventor of certain new and useful improvements in LOCK-OUT DEVICE AND SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE INCLUDING THE SAME, for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. I hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. _______, filed _______) the application number and the filing date of said application when known or to file this Assignment concurrently with the application; and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

I hereby request that said Letters Patent be issued in accordance with this assignment.

Page 1 of 2

ASSIGNMENT – CONTINUED

I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and I hereby instruct, and further covenant and agree to bind my heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

of, 20_		I have h	ereunto set my	hand and seal on this _	<u> </u>
-	Pan.		KWaŁ uk Kwak	(SEAL)	

Witnessed by:		
Date:	 	

RECORDED: 10/05/2005

2 of 2

PATENT REEL: 017067 FRAME: 0610